

Harima Chemicals Group, Inc. completes acquisition of commercial rights, assets, etc. related to the solder materials business of Henkel AG & Co. KGaA (supplemental materials)

Harima Chemicals Group, Inc.

Overview of this acquisition

Details	<ul style="list-style-type: none">• Purchase of assets related to the solder materials business of Henkel AG & Co. KGaA (Henkel)• Transfer of 90 plant employees and research and technical sales staff• Provision by Henkel of support for the launch of the business by Harima after purchase of the assets
Main products	<ul style="list-style-type: none">• Solder paste, flux cored solder, accessories (e.g., chemicals related to solder products)
Date of completion	June 1, 2022
Acquisition price	Undisclosed under terms of the contract with Henkel

Aims of this acquisition

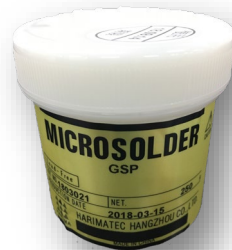


Growing market share, expanding customer base

Enhancing competitive strengths in global markets

Expanding the product lineup

Increasing production efficiency through growth in business scale



The global network of the solder business after this acquisition

(UK)
Harima UK Ltd
Newly established



Development/technological sales facility

(China)
Harimatec Hangzhou Co., Ltd.

(USA)
Harimatec Inc.

(Czech Republic)
Harimatec Czech, s.r.o.

(Japan)
Harima Chemicals, Inc.
Nippon Filler Metals, Ltd.

(Malaysia)
Harimatec Malaysia Sdn.Bhd.
Achievement of a two-plant structure with
the acquisition of the Ipoh Plant



Ipoh Plant

Strengths of products acquired through this acquisition

Product	Strengths
Highly reliable solder paste (product name: 90iSC)	A key product for auto-parts makers, offering more durable solder joints
Halogen-free solder paste	Compatible with EU environmental regulations (RoHS, REACH)
Solder paste storable at room temperature (product name: GC)	Capable of storage for one year at room temperature. Reduces storage costs and contributes to carbon neutrality.
Dispensable solder paste	Compatible with changes in manufacturing methods through miniaturization of electronic devices

Strengthening sales through expansion of the product lineup and integration of technologies

Electronic Materials Business growth strategy

Our Electronic Materials Business Company will pursue business growth in areas such as solder materials, functional resins for semiconductors, and brazing materials that support technological advances such as automotive electrification and self-driving, 5G telecommunications, and digital transformation (DX). The solder materials business that is the subject of this acquisition also plays a role as a vital component of the growth strategies in the New Harima 2026 medium-term management plan for the period through FY2026.

